

Title (en)

Wood material board production assembly and method for manufacturing a wood material board

Title (de)

Holzwerkstoffplatten-Herstellanlage und Verfahren zum Herstellen einer Holzwerkstoffplatte

Title (fr)

Installation de fabrication de plaques en matériau dérivé du bois et procédé de fabrication d'une plaque en matériau dérivé du bois

Publication

EP 2927003 B1 20160330 (DE)

Application

EP 14163278 A 20140402

Priority

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Abstract (en)

[origin: WO2015149894A1] The invention relates to an engineered wood board production installation for producing an engineered wood board (48), in particular high density fiberboard, said installation having an engineered wood board workpiece production device (12) for producing an engineered wood board workpiece (18) and a digital printing device (14) for printing the engineered wood board workpiece (18). According to the invention, a temperature measurement device (34) is provided which is disposed in order to determine an entering temperature (T14) of the engineered wood board workpiece (18) during printing.

IPC 8 full level

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Cited by

WO2018046390A1; US10442112B2; EP3292995A1; CN109789658A; EP3181313B1; EP3960479A1; WO2022043307A1; US11097502B2; DE202017007606U1

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